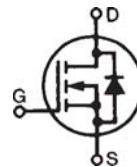


**HiPerFET™
Power MOSFET
Q2-Class**

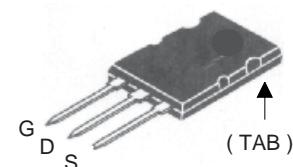
IXFB38N100Q2

N-Channel Enhancement Mode
Avalanche Rated, Low Q_g , Low Intrinsic R_G
High dV/dt , Low t_{rr}



V_{DSS} = 1000V
 I_{D25} = 38A
 $R_{DS(on)}$ ≤ 250mΩ
 t_{rr} ≤ 300ns

PLUS264™(IXFB)



G = Gate D = Drain
S = Source TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ\text{C}$ to 150°C	1000		V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 150°C , $R_{GS} = 1\text{M}\Omega$	1000		V
V_{GSS}	Continuous	± 30		V
V_{GSM}	Transient	± 40		V
I_{D25}	$T_c = 25^\circ\text{C}$	38		A
I_{DM}	$T_c = 25^\circ\text{C}$, pulse width limited by T_{JM}	152		A
I_A	$T_c = 25^\circ\text{C}$	38		A
E_{AS}	$T_c = 25^\circ\text{C}$	5		J
dV/dt	$I_s \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$	20		V/ns
P_D	$T_c = 25^\circ\text{C}$	890		W
T_J		-55 ... +150		°C
T_{JM}		150		°C
T_{stg}		-55 ... +150		°C
T_L	1.6 mm (0.063 in.) from case for 10s	300		°C
T_{SOLD}	Plastic body for 10s	260		°C
F_c	Mounting force	30..120/6.7..27		N / lbs
Weight		10		g

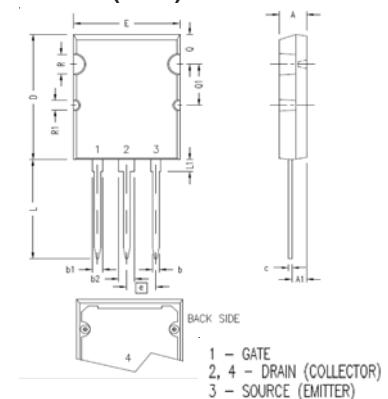
Symbol	Test Conditions	Characteristic Values		
		($T_J = 25^\circ\text{C}$, unless otherwise specified)	Min.	Typ.
BV_{DSS}	$V_{GS} = 0\text{ V}$, $I_D = 1\text{mA}$	1000		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 8\text{mA}$	3.0		5.5 V
I_{GSS}	$V_{GS} = \pm 30\text{ V}$, $V_{DS} = 0\text{V}$		± 200	nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$	$T_J = 125^\circ\text{C}$		50 μA 3 mA
$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Note 1		250	mΩ

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$V_{DS} = 20\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Note 1	24	40	S
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	13.5	nF	
		1035	pF	
		180	pF	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$ $R_G = 1\Omega$ (External)	25	ns	
		28	ns	
		57	ns	
		15	ns	
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$	250	nC	
		60	nC	
		105	nC	
R_{thJC}			0.14	°C/W
R_{thCS}		0.13		°C/W

Source-Drain Diode

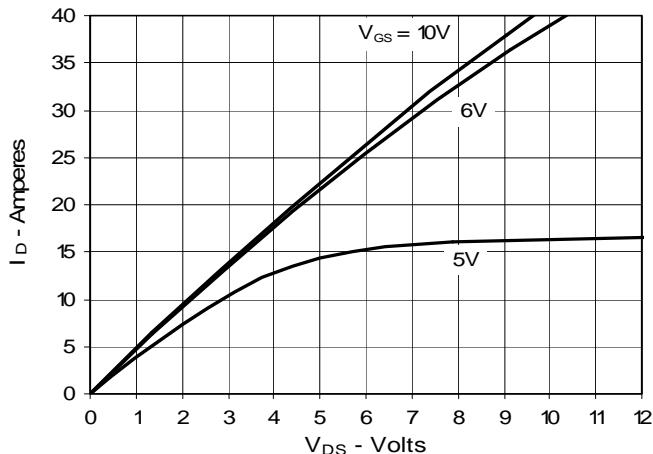
Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
I_s	$V_{GS} = 0\text{V}$		38	A
I_{SM}	Repetitive, pulse width limited by T_{JM}		152	A
V_{SD}	$I_F = I_S$, $V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr} Q_{RM} I_{RM}	$I_F = 25\text{A}$, $V_{GS} = 0\text{V}$ -di/dt = 100 A/μs $V_R = 100\text{ V}$		300	ns
			1.4	μC
			9	A

Note: 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

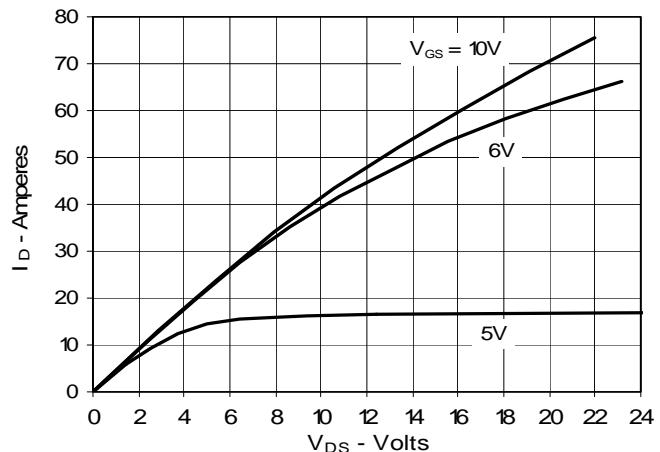
PLUS264™ (IXFB) Outline

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.185	.209	4.70	5.31
A1	.102	.118	2.59	3.00
b	.037	.055	0.94	1.40
b1	.087	.102	2.21	2.59
b2	.110	.126	2.79	3.20
c	.017	.029	0.43	0.74
D	1.007	1.047	25.58	26.59
E	.760	.799	19.30	20.29
e	.215	BSC	5.46	BSC
L	.779	.842	19.79	21.39
L1	.087	.102	2.21	2.59
Q	.240	.256	6.10	6.50
Q1	.330	.346	8.38	8.79
ØR	.155	.187	3.94	4.75
ØR1	.085	.093	2.16	2.36

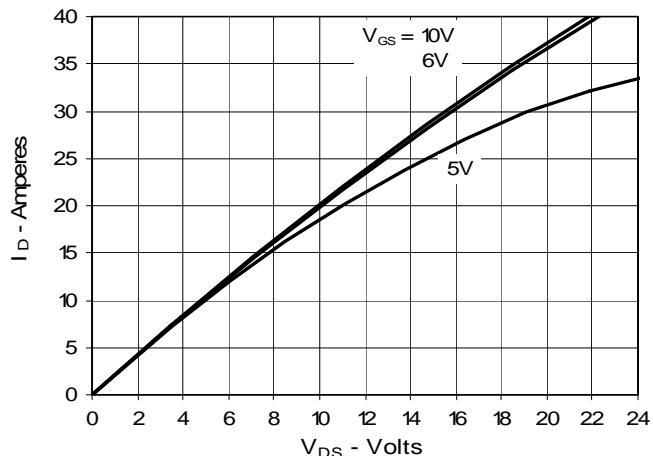
**Fig. 1. Output Characteristics
@ 25°C**



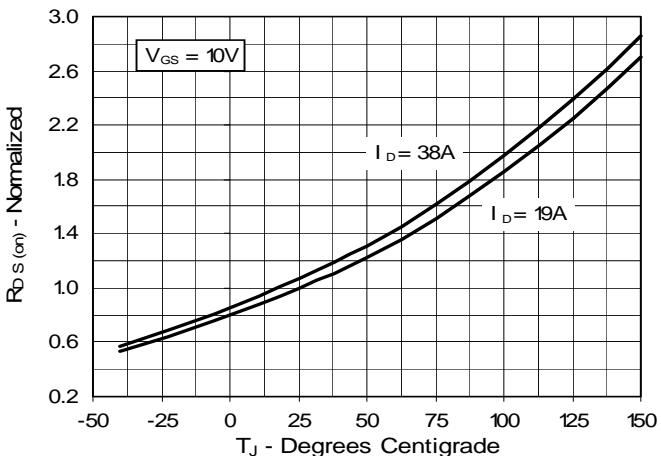
**Fig. 2. Extended Output Characteristics
@ 25°C**



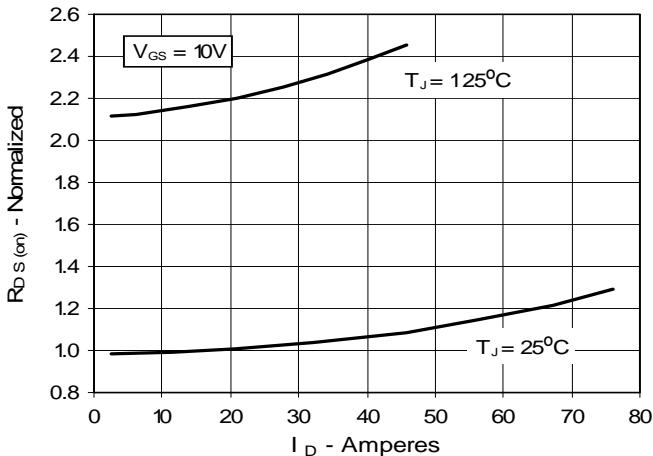
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 19A$
Value vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 19A$
Value vs. Drain Current**



**Fig. 6. Drain Current vs.
Case Temperature**

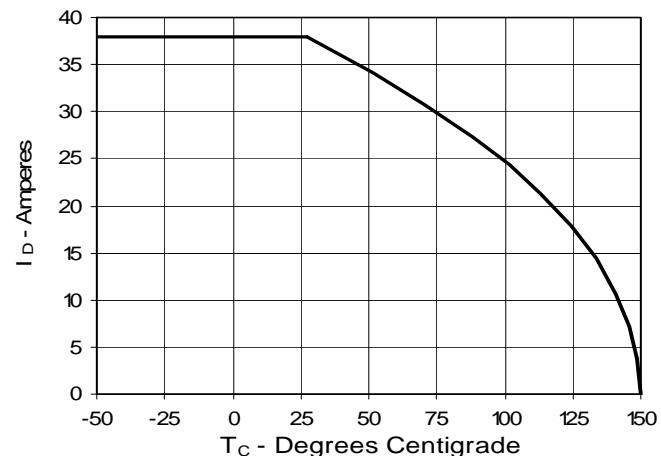
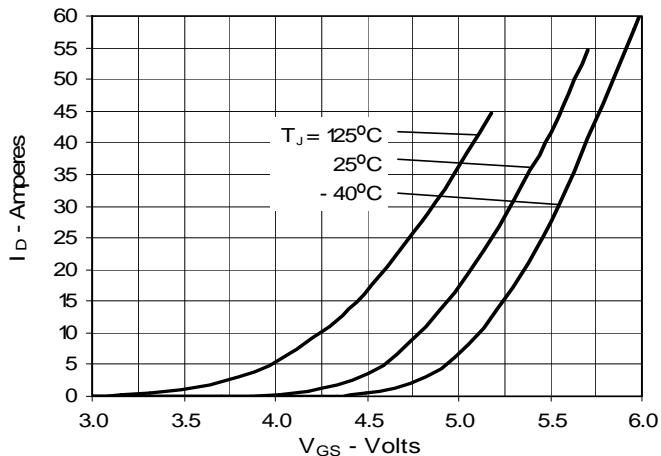
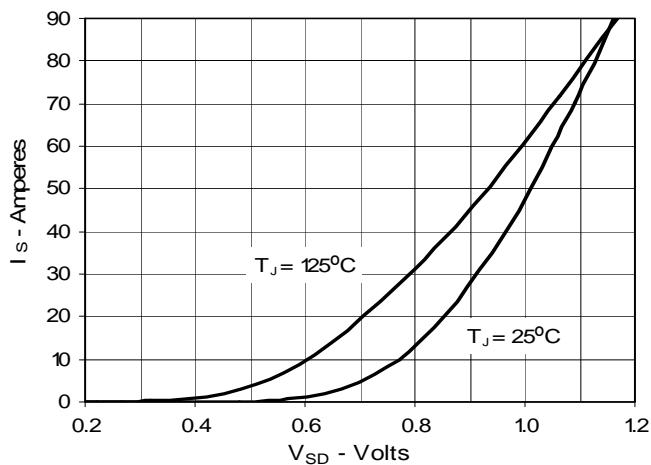
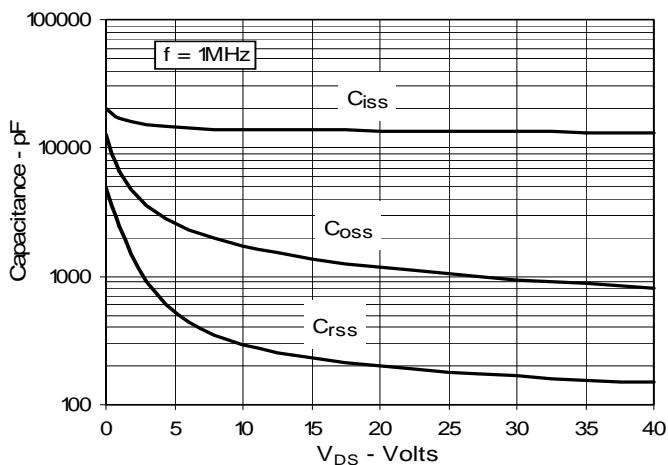
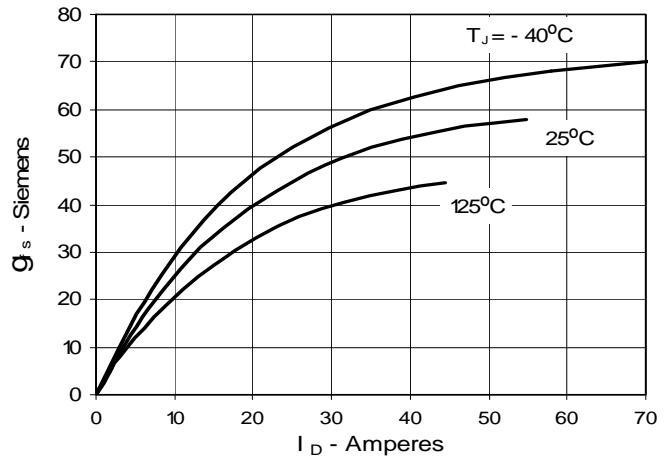
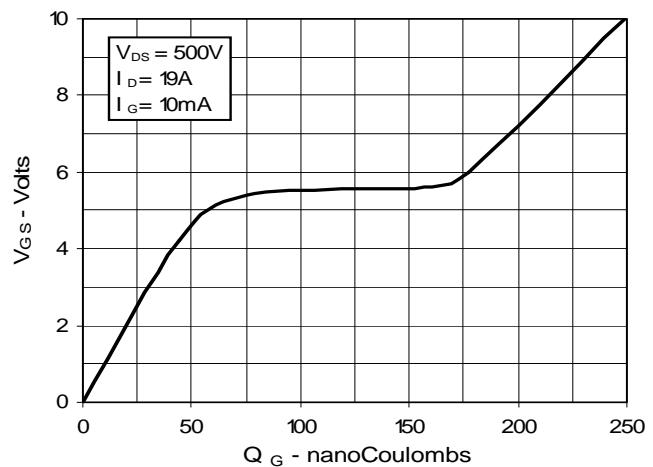
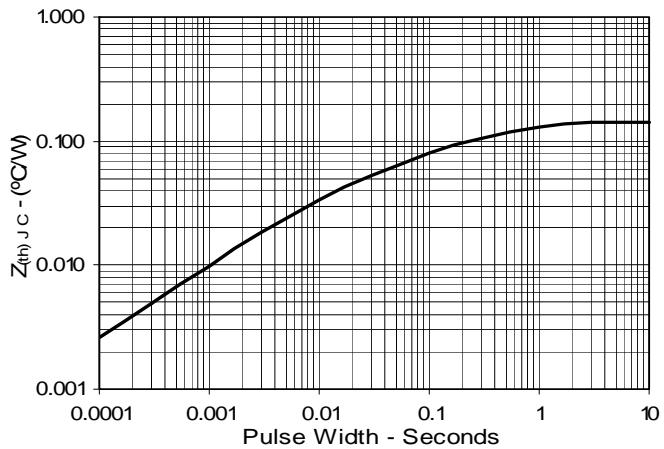


Fig. 7. Input Admittance**Fig. 9. Source Current vs. Source-To-Drain Voltage****Fig. 11. Capacitance****Fig. 8. Transconductance****Fig. 10. Gate Charge****Fig. 12. Maximum Transient Thermal Impedance**



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